Digital VLSI Design

Lecture 1: Introduction

Semester A, 2018-19

Lecturer: Dr. Adam Teman

20 October 2018

Emerging Nanoscaled
Integrated Circuits and Systems Labs

Bar-Ilan University
אוניברסיטת בר-אילן

EnICS Labs @BIU

"Educating the future of chip design in Israel."

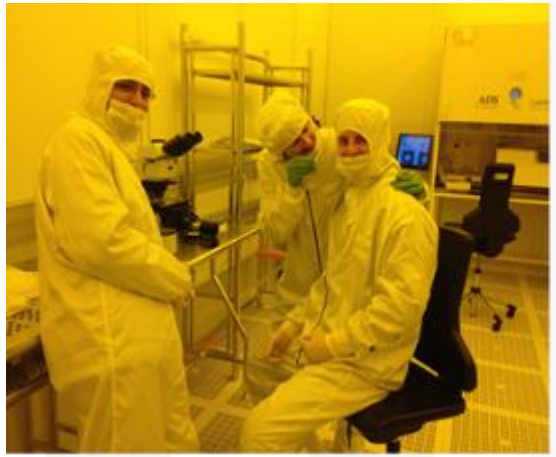
Faculty of Engineering

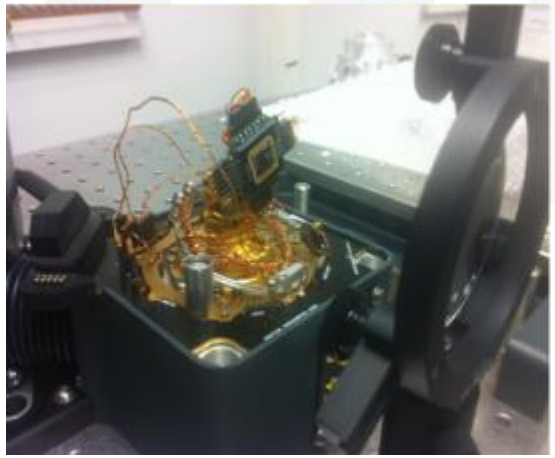
Electrical Engineering

NanoElectronics Track

EnICS

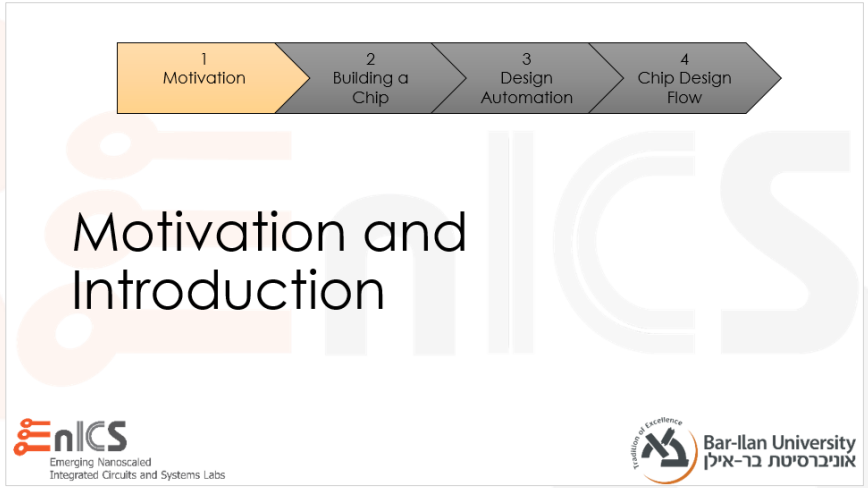
Emerging Nanoscaled Integrated Circuits and Systems Labs

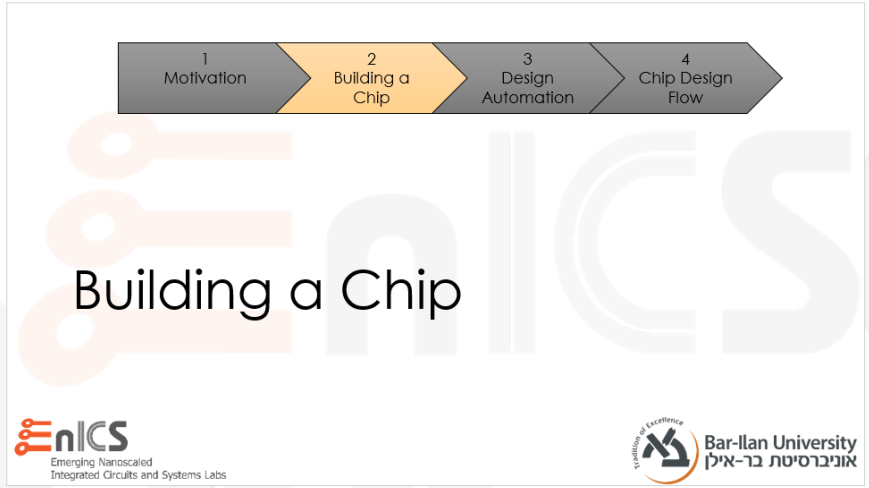


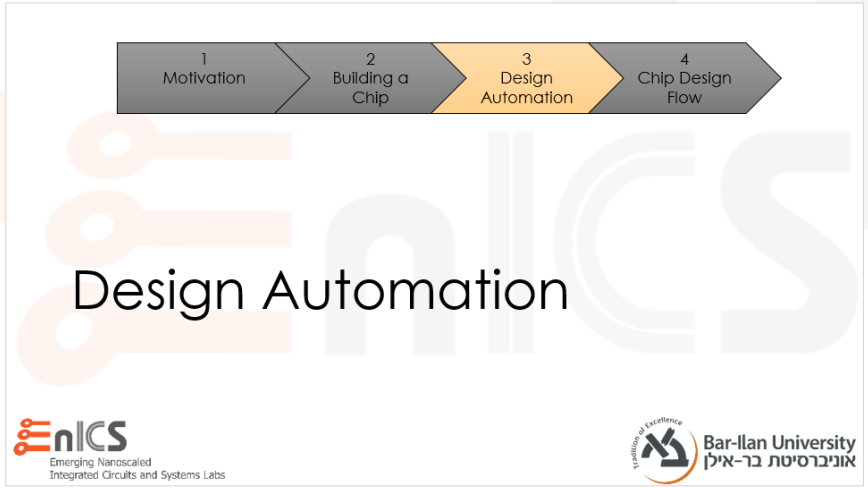


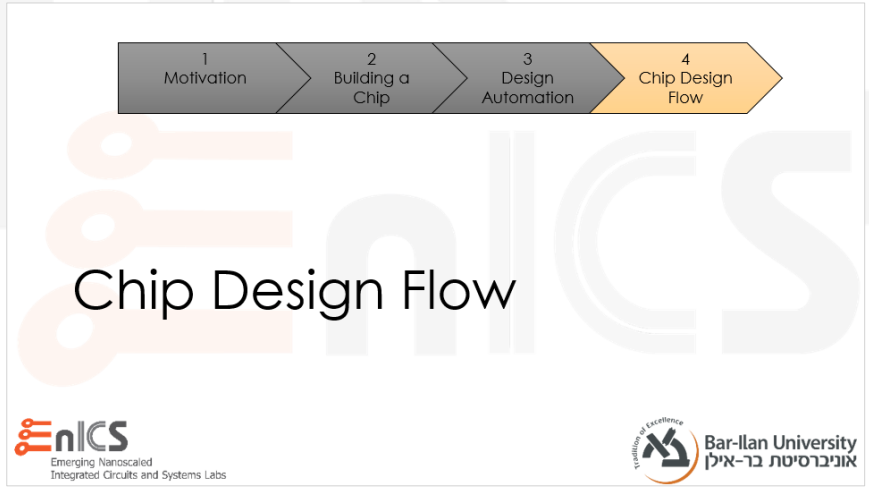
Bar-Ilan University

Lecture Outline



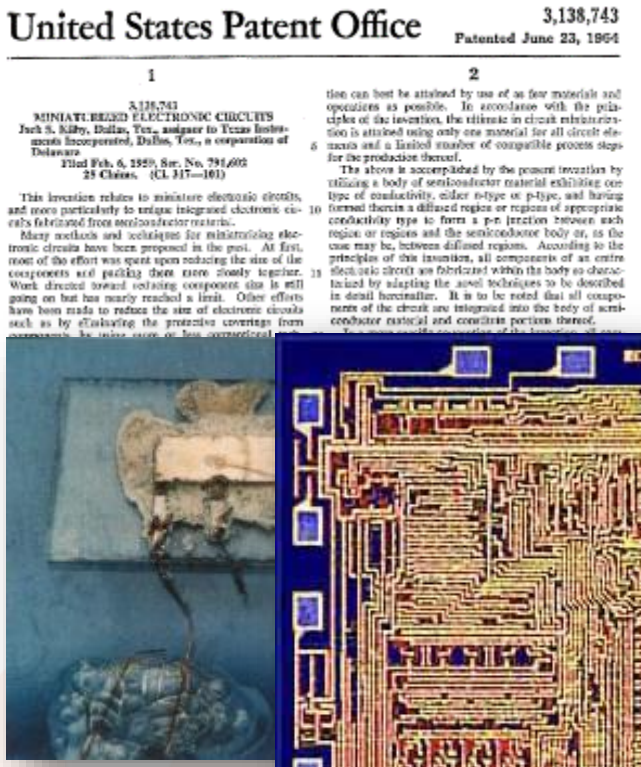






Motivation and Introduction

Motivation



United States Patent Office 3,138,743 Patented June 23, 1964

MINIATURIZED ELECTRONIC CIRCUITS

Jack S. Kilby, Dallas, Tex., assignor to Texas Instruments Incorporated, Dallas, Tex., a corporation of Delaware

Filed Feb. 6, 1959, Ser. No. 791,602

25 Claims. (Cl. 317—101)

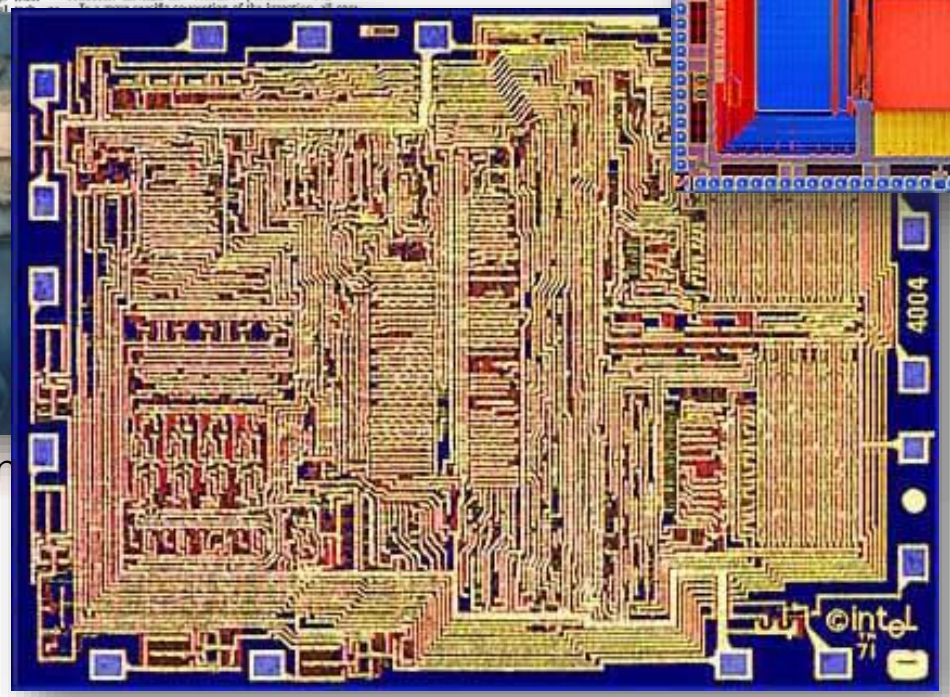
This invention relates to miniature electronic circuits, and more particularly to unique integrated electronic circuits fabricated from semiconductor materials.

Many methods and techniques for miniaturizing electronic circuits have been proposed in the past. At first, most of the effort was spent upon reducing the size of the components and packing them more closely together. Work directed toward reducing component size is still going on but has nearly reached a limit. Other efforts have been made to reduce the size of electronic circuits such as by fabricating the protective coverings from

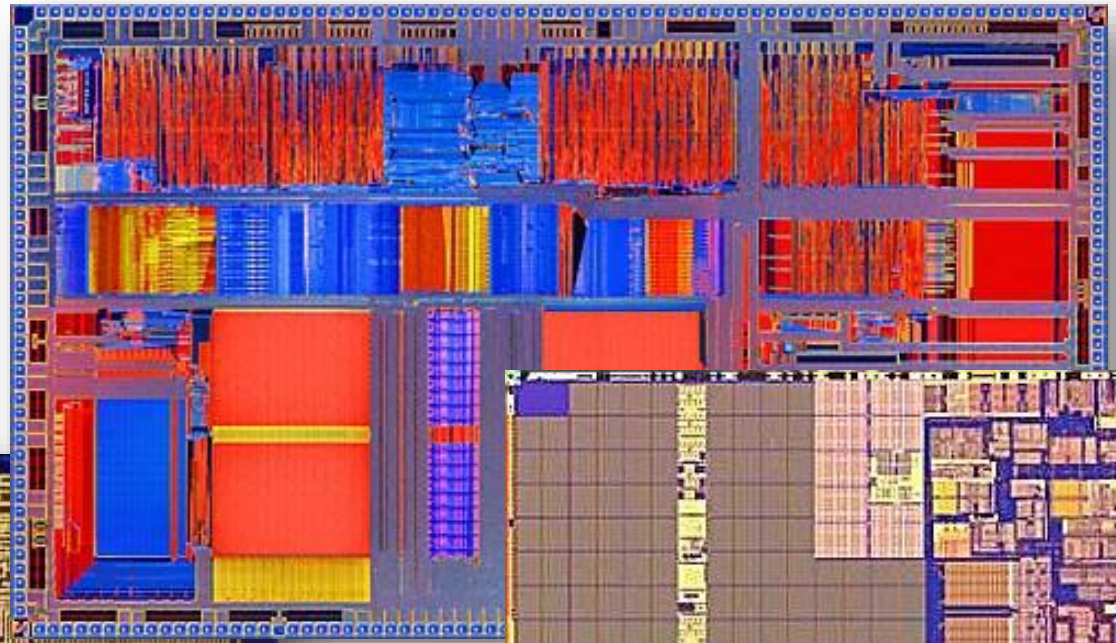
tion can best be attained by use of as few materials and operations as possible. In accordance with the principles of the invention, the ultimate in circuit miniaturization is attained using only one material for all circuit elements and a limited number of compatible process steps for the production thereof.

The above is accomplished by the present invention by utilizing a body of semiconductor material exhibiting one type of conductivity, either n-type or p-type, and having formed therein a diffused region or regions of appropriate conductivity type to form a p-n junction between each region or regions and the semiconductor body or, as the case may be, between diffused regions. According to the principles of this invention, all components of an entire electronic circuit are fabricated within the body so characterized by adapting the novel techniques to be described in detail hereinafter. It is to be noted that all components of the circuit are integrated into the body of semiconductor material and constitute portions thereof.

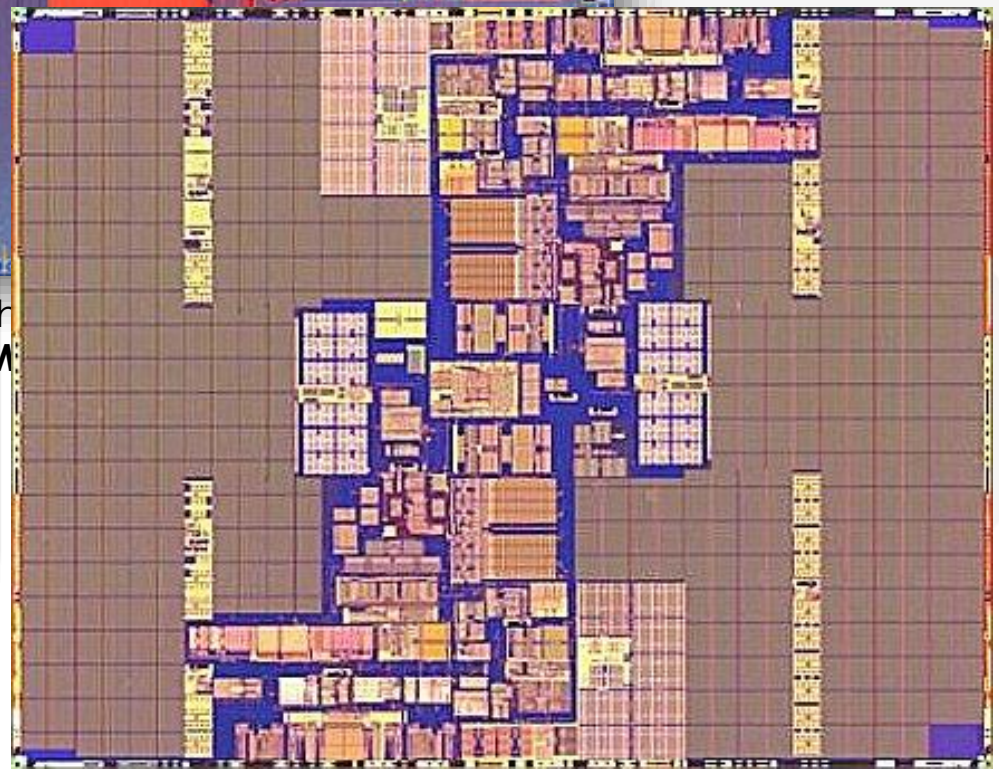
1964 – The In



1971 – The Intel 4004
2,300 Transistors



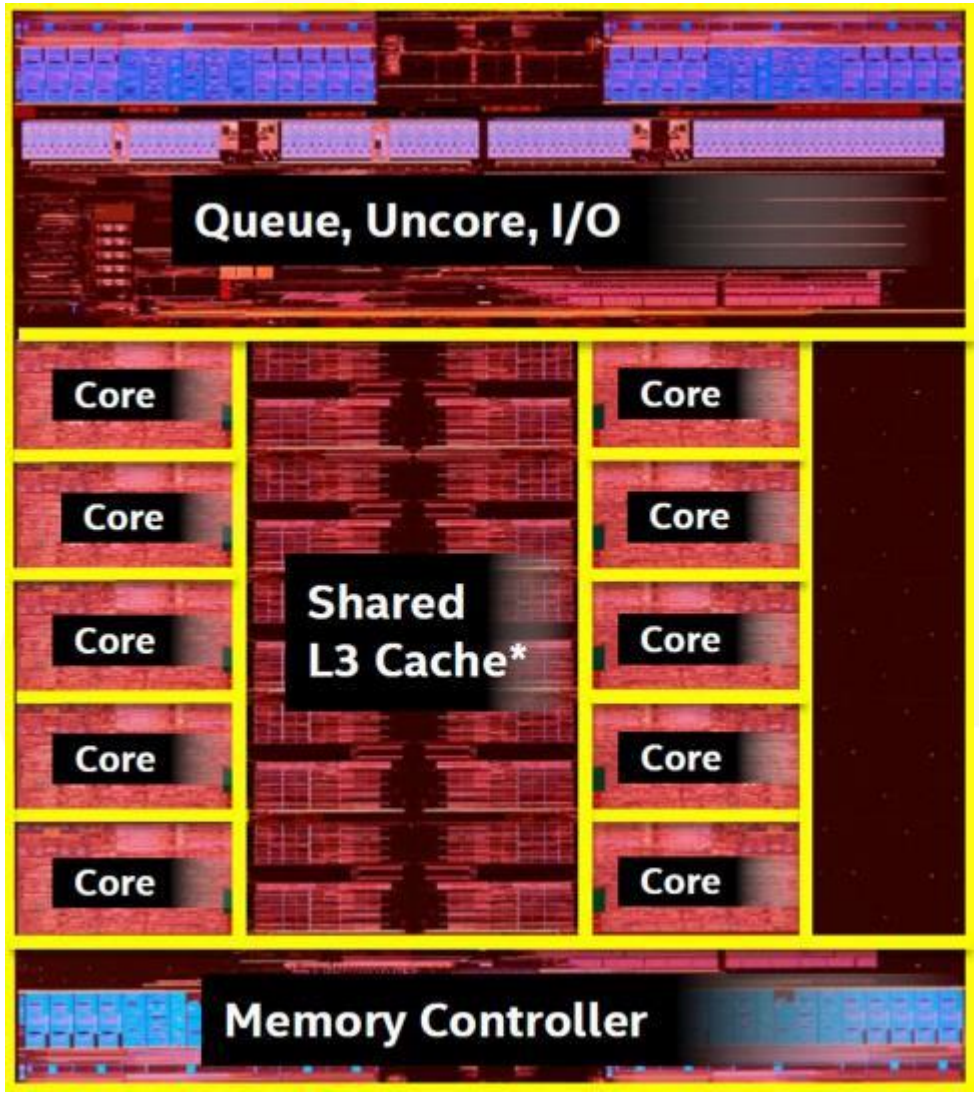
1992 – Th
1.2**M**

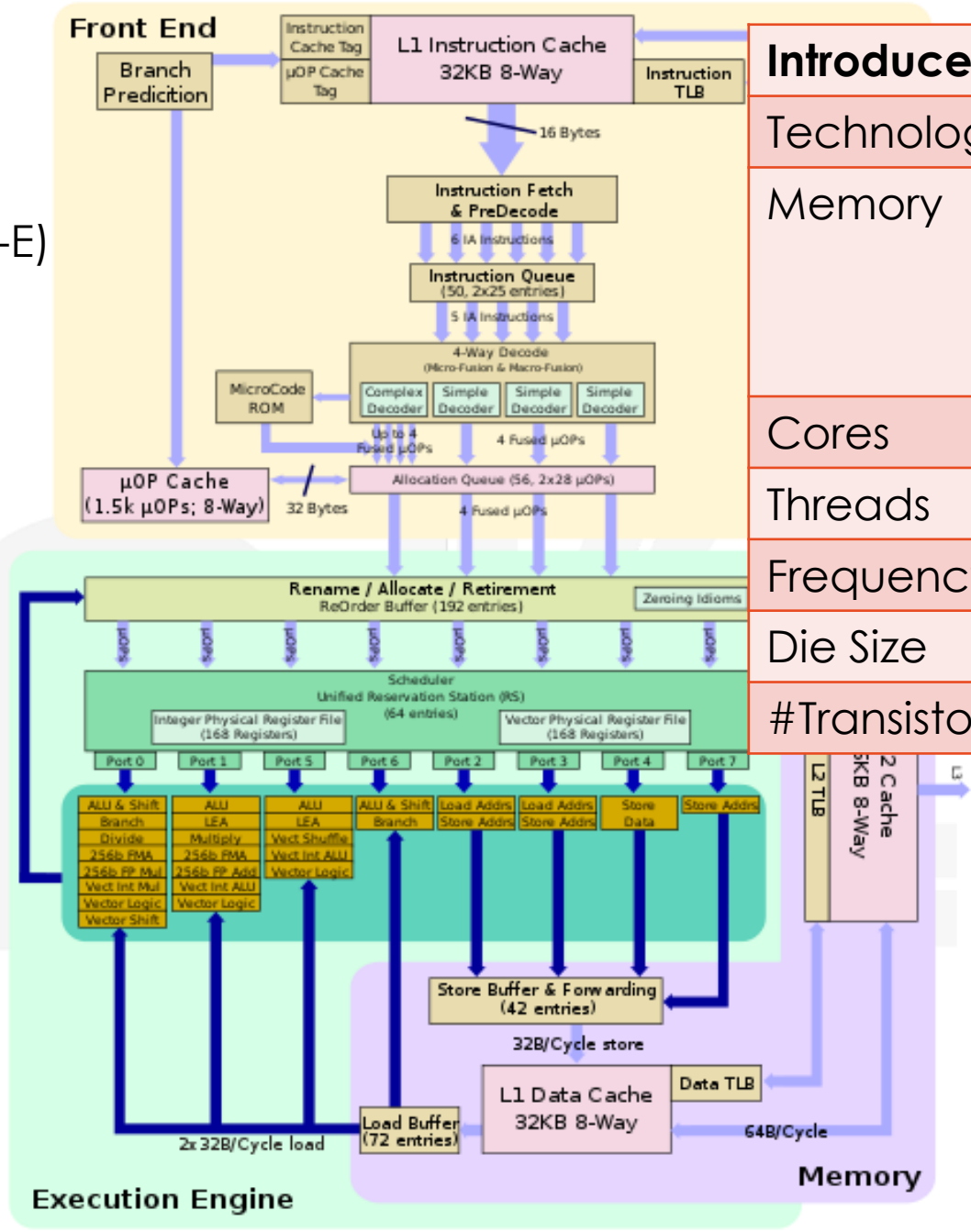


2006 – Itanium 2 “Montecito”
1.7**B** Transistors

Motivation

Core i7-6950X Extreme Edition (Broadwell-E)



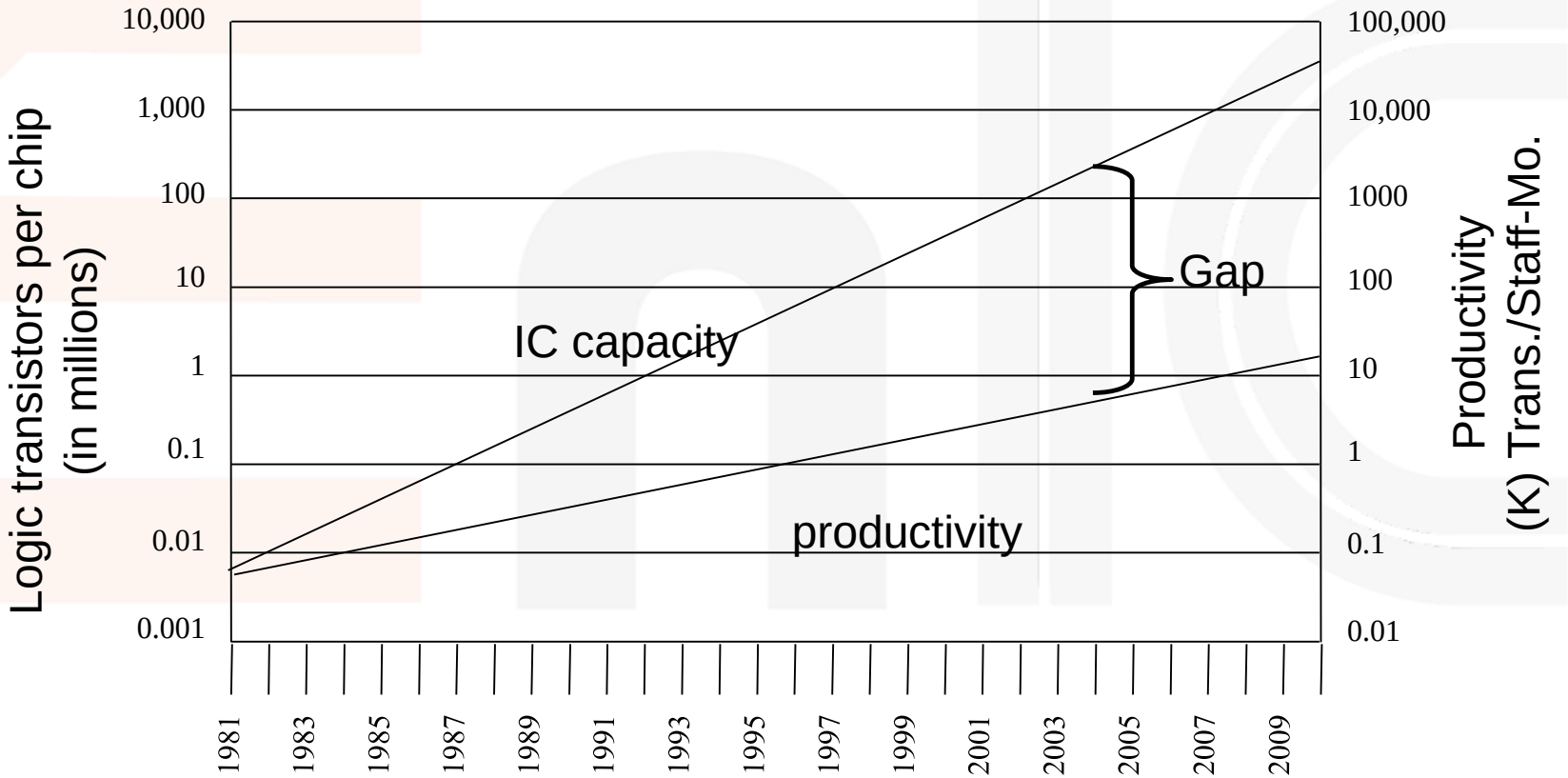


Introduced	May 2016
Technology	14nm FinFET
Memory	320KB L1-I$ 320KB L1-D$ 2.56MB L2$ 25MB L3$
Cores	10
Threads	20
Frequency	3.0-3.5 GHz
Die Size	246 mm^2
#Transistors	3.2 B

http://en.wikichip.org/wiki/intel/core_i7ee/i7-6950x

Motivation

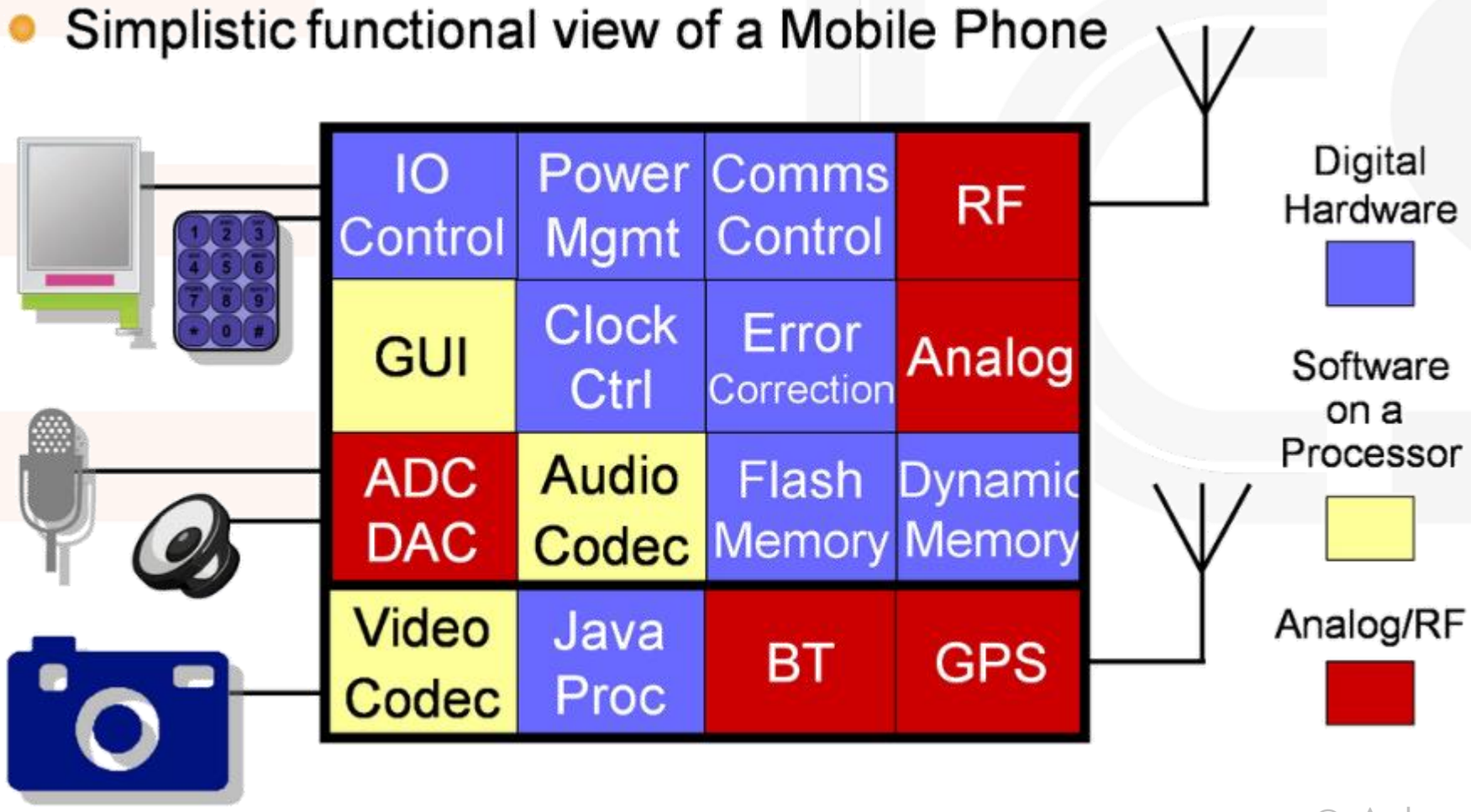
- **Houston, we have a problem…**



"Moore's Law of Engineers"

Motivation

- **How on earth do we design such a thing???**



The Solution:

Design Abstraction

Design Automation

Design Re-use (IP)

Syllabus

- Lecture 1: Introduction
- Lecture 2: Verilog
- Lecture 3: Logic Synthesis
- Lecture 4: Static Timing Analysis
- Lecture 5: Moving to the Physical Domain
- Lecture 6: Placement
- Lecture 7: Clock Tree Synthesis
- Lecture 8: Routing
- Lecture 9: I/O and Packaging
- Lecture 10: Design for Test

References

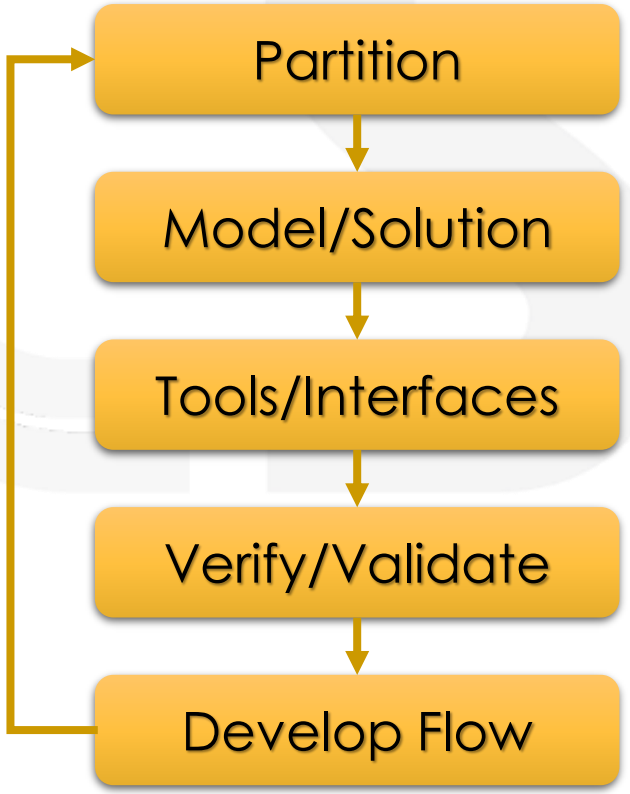
- **Way too many to state all, and hopefully many are cited on the slides themselves, but here are a few:**
  - Rob Rutenbar – “From Logic to Layout” (available on Coursera)
  - Nir Sever – Low Power Design (BGU)
  - Roy Shor – תכן לוגי (BGU)
  - IDESA Digital Design Course
  - Rabaey “Digital Integrated Circuits” 2nd Edition
  - Weste, Harris “CMOS VLSI Design”
  - Google (oh, thank you Google!)
  - Cadence Support (support.cadence.com)
  - Synopsys SolveNet (solvenet.synopsys.com)
  - And many, many more…

Building a Chip

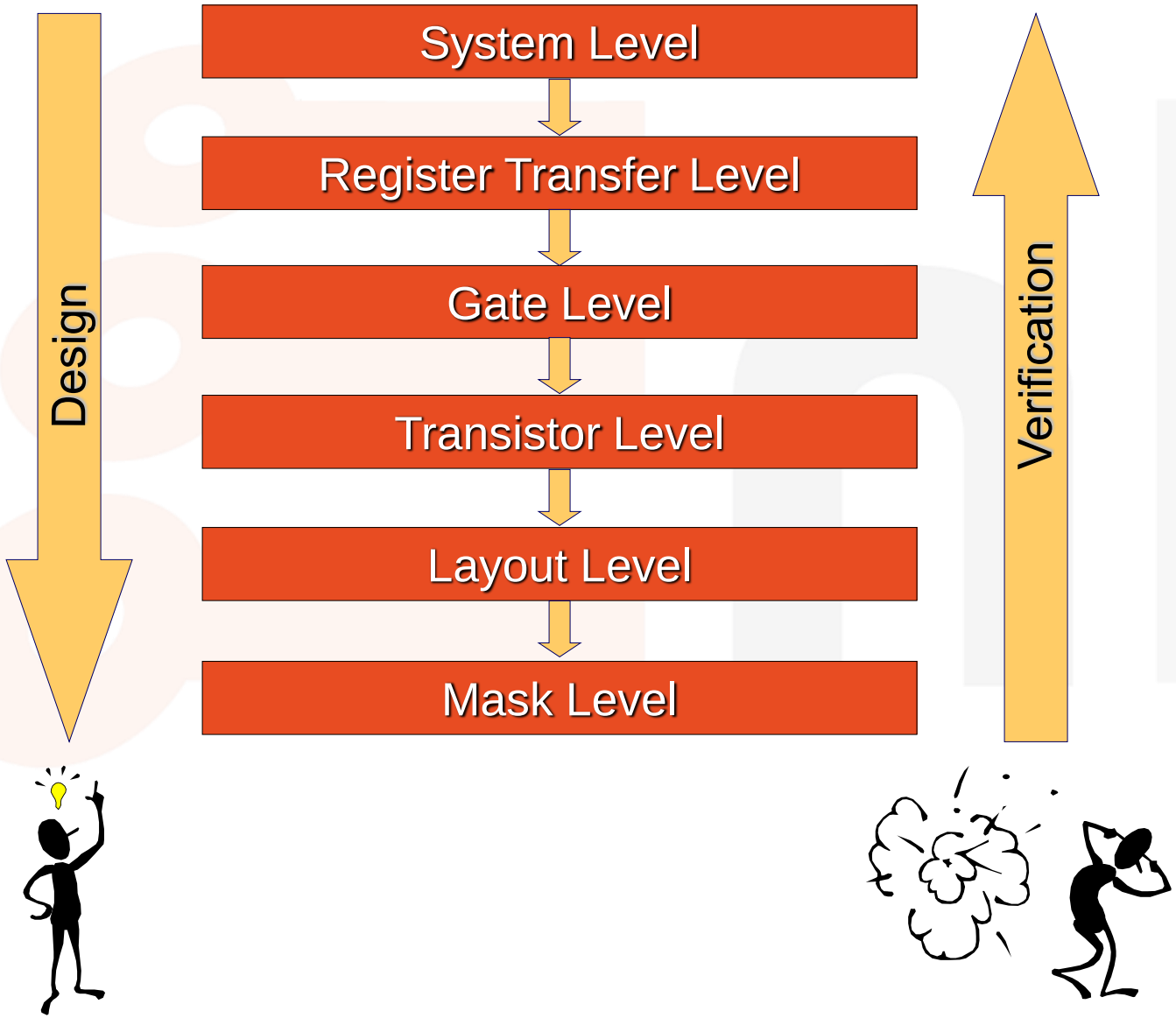
General Design Approach

- **How do engineers build a bridge?**

- **Divide and conquer !!!!**
  - **Partition** design problem into many sub-problems, which are manageable
  - Define mathematical **model** for sub-problem and find an **algorithmic** solution
    - Beware of model limitations and check them !!!!!!!
  - Implement algorithm in **individual design tools**, define and implement general **interfaces** between the tools
  - Implement **checking tools** for boundary conditions
  - Concatenate design tools to general **design flows** which can be managed
  - See what doesn't work and **start over**.



Basic Design Abstraction



Another view:

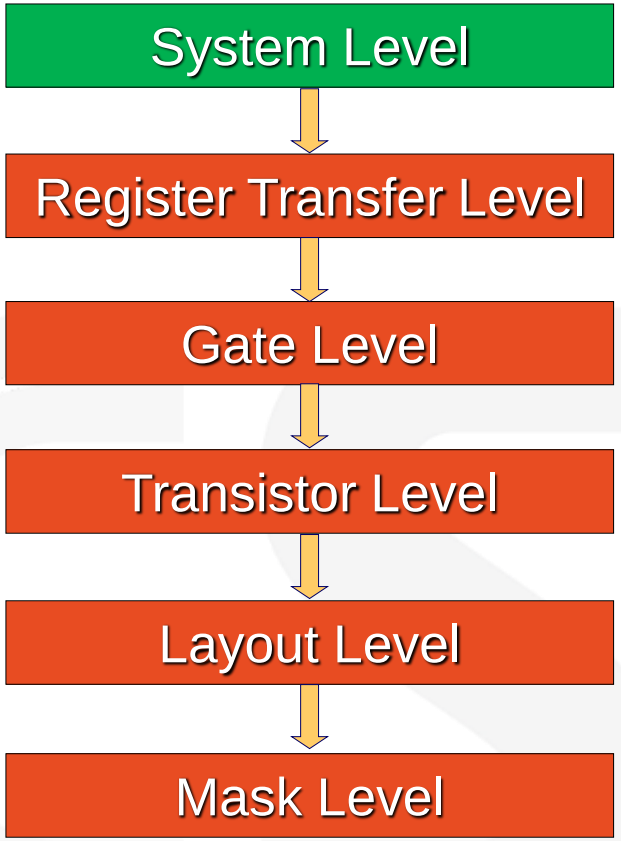
- Application
- Algorithm
- Programming Language
- OS / Virtual Machine
- Instruction Set Architecture
- Microarchitecture
- Register-Transfer Level
- Circuits
- Devices
- Physics

System Level Abstraction

- **Abstract algorithmic description of high-level behavior**
  - e.g., C-Programming language

```
Port* compute_optimal_route_for_packet
          (Packet_t *packet, Channel_t *channel)
   {
      static Queue_t *packet_queue;
      packet_queue = add_packet(packet_queue, packet);
      ...
   }
```

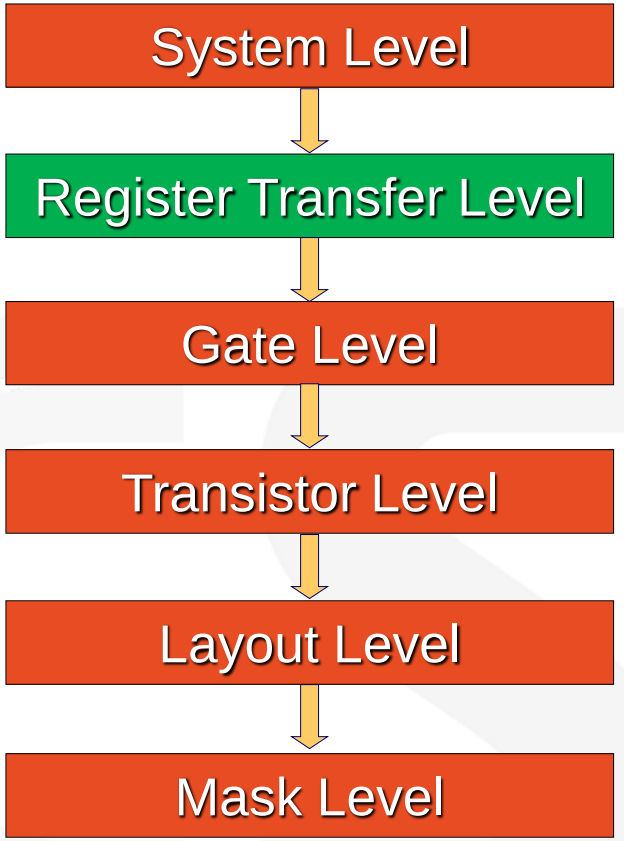
  - Abstract because it does not contain any implementation details for timing or data
  - Efficient to get a compact execution model as a first design draft
  - Difficult to maintain throughout project because no link to implementation



Register-Transfer Level (RTL)

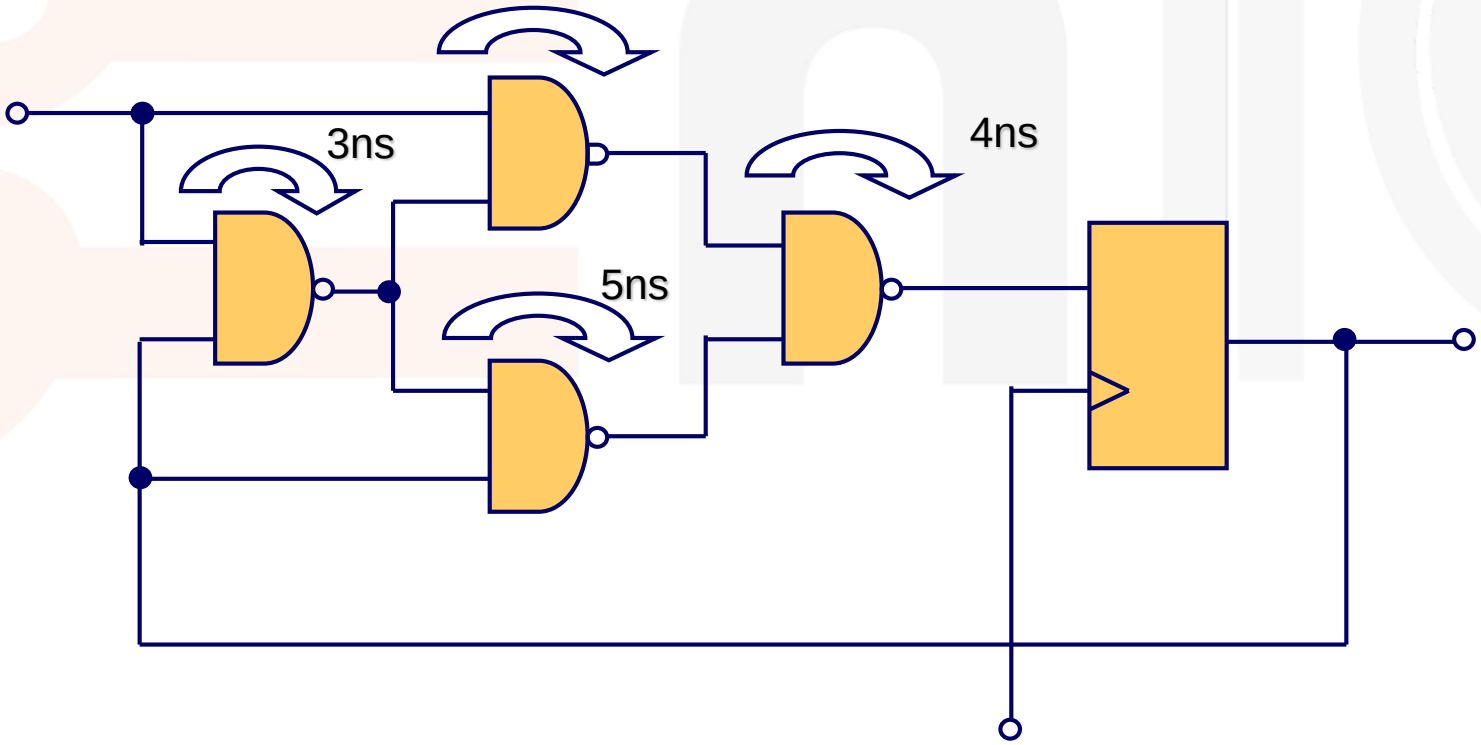
- **Cycle accurate model "close" to the hardware implementation**
  - bit-vector data types and operations as abstraction from bit-level implementation
  - sequential constructs (e.g., `if-then-else`, `while` loops) to support modeling of complex control flow

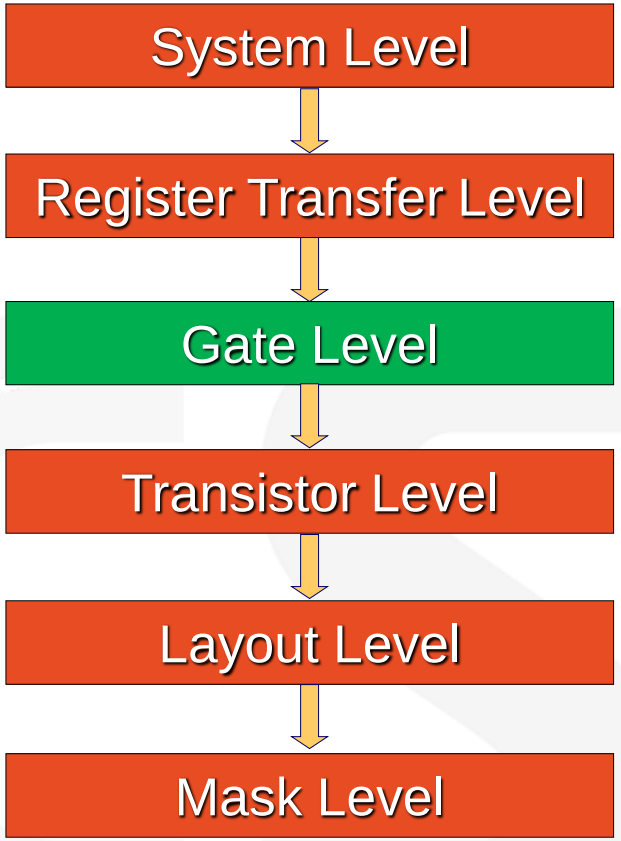
```
module mark1;
  reg [31:0] m[0:8192];
  reg [12:0] pc;
  reg [31:0] acc;
  reg[15:0] ir;

  always
   begin
     ir = m[pc];
     if(ir[15:13] == 3b'000)
        pc = m[ir[12:0]];
     else if (ir[15:13] == 3'b010)
        acc = -m[ir[12:0]];
     ...
   end
endmodule
```



Gate Level Abstraction (GTL)

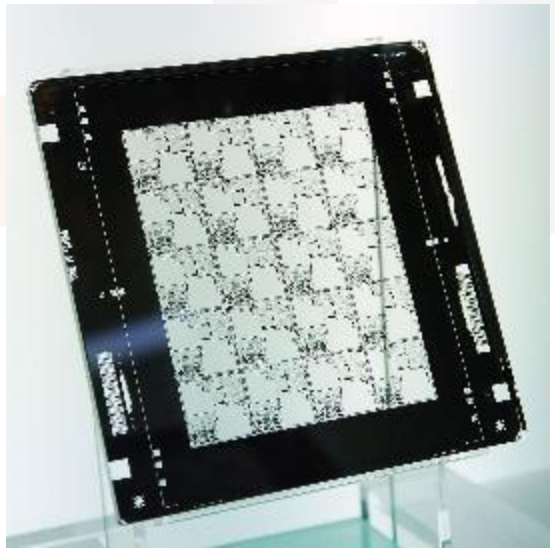
- **Model on finite-state machine level**
  - Models function in Boolean logic using registers and gates
  - Various delay models for gates and wires

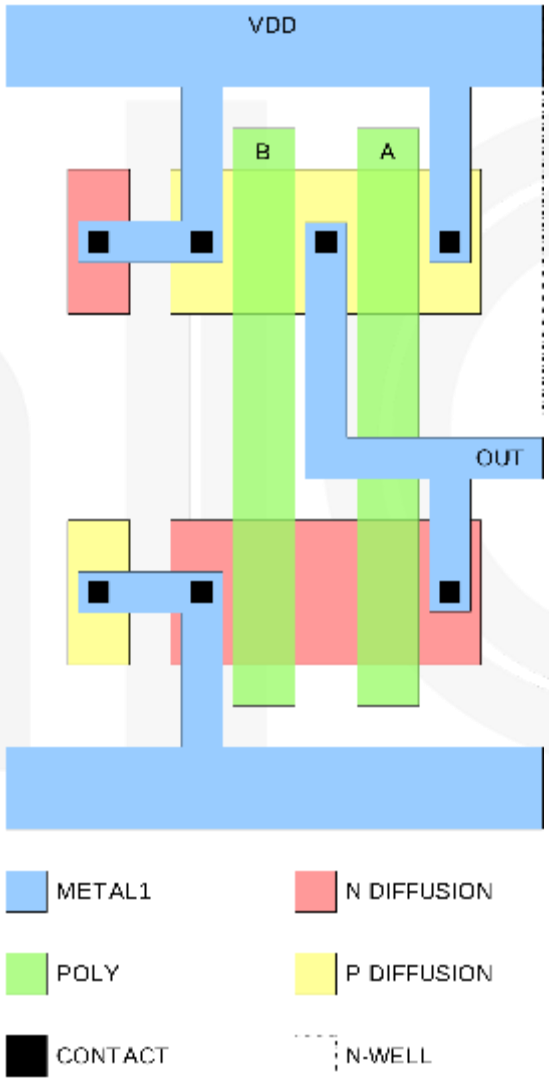


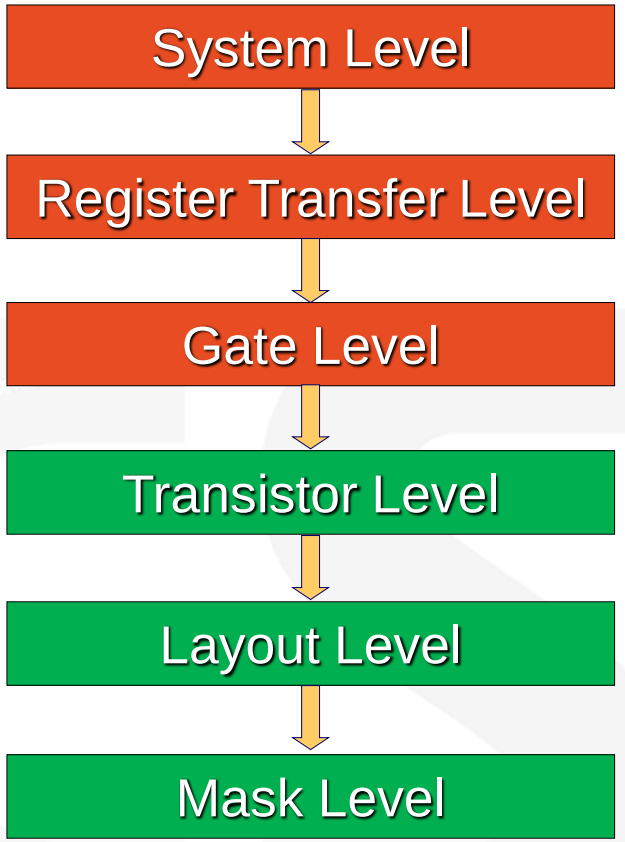


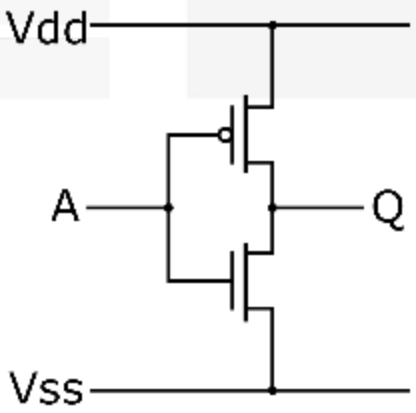
Transistor to Mask Level

- **As we've seen in previous courses:**
  - Transistor Level:
    - Use *compact models* to enable accurate circuit simulation.
  - Layout Level:
    - Draw polygons to implement the devices and interconnect.
  - Mask Level:
    - Create actual photo-masks for performing lithography during fabrication process.









Images courtesy of wikipedia

The Chip Hall of Fame

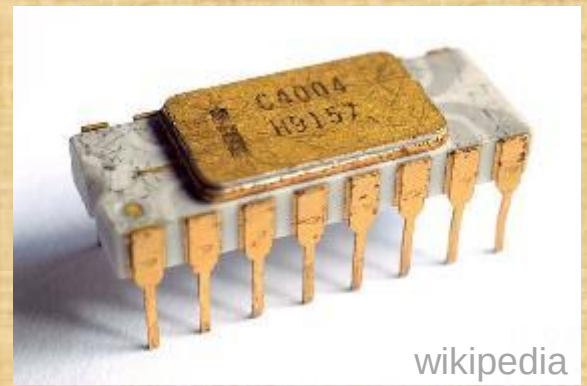
- **To get started, let's remember the CPU that started it all**

The Intel 4004 Microprocessor

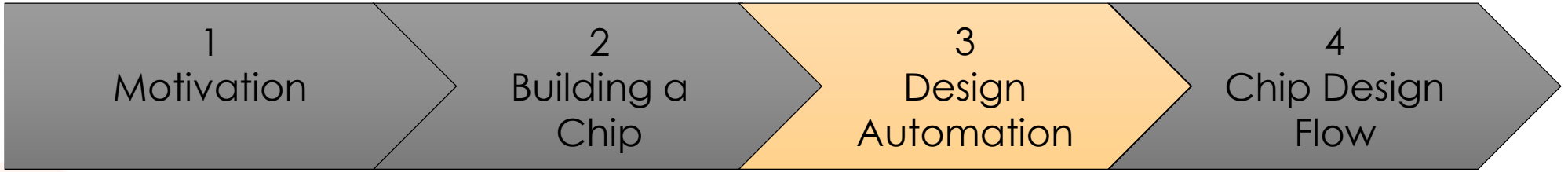
- The first commercially available monotlithic CPU.
- Release date: March 1971
- Transistor Count: 2,300 Process: 10 um pMOS
- Frequency: 740 KHz 4-bit data bus
- Designed as a side project to drum up some cash, while Intel developed its *real* product line, memory chips.
- Developed as part of a 4-chip product line (MCS-4 chipset) for the Busicom calculator.

The Busicom Calculator

Federico Faggin and the 4004 layout



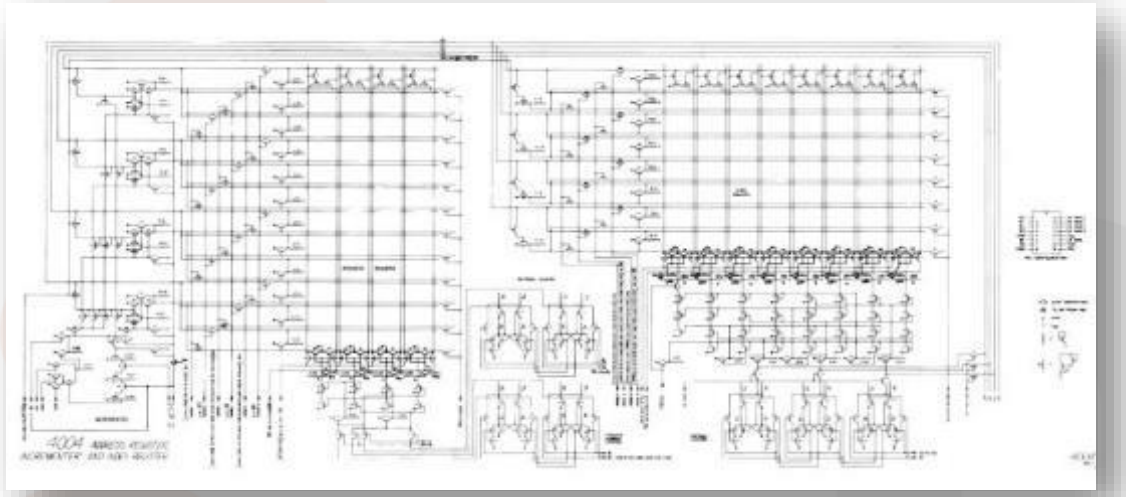
2018 Inductee to the IEEE Chip Hall of Fame



Design Automation

The (really) Olden Days

- **Early chips were prepared entirely by hand:**



Schematic of Intel 4004 (1971)

Mainframe CAD System (1967)

http://www.computerhistory.org/revolution/digital-logic

The (really) Olden Days

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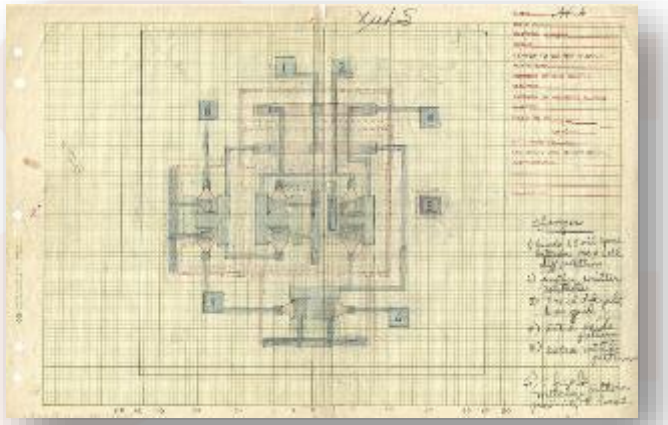
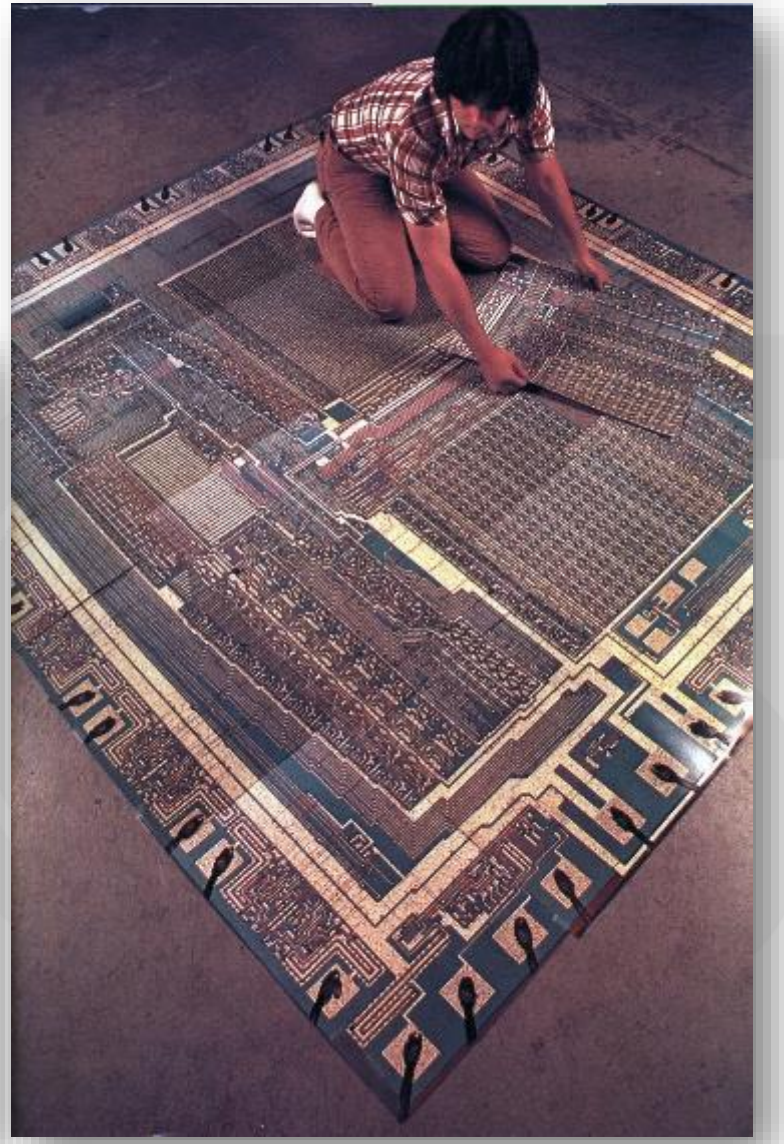
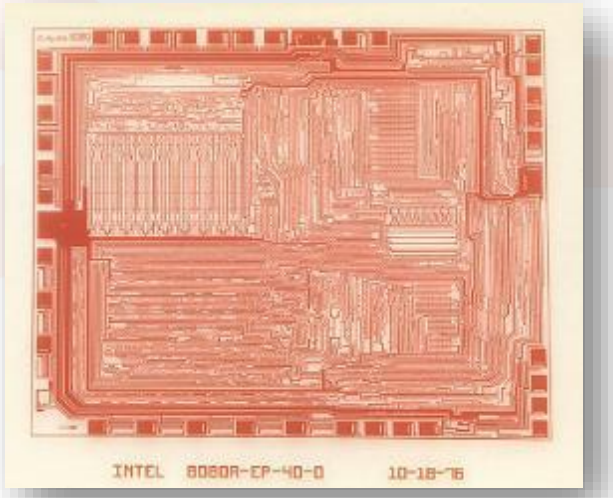


Hand drawn gate layout (Fairchild)

Rubylith Operators (1970)



The original Tape-Out?



8088A Mask Transparent Overlays (1976)

http://www.computerhistory.org/revolution/digital-logic

Design Automation Today

Design:
- High-Level Synthesis
- Logic Synthesis
- Schematic Capture
- Layout
- PCB Design

Simulation:
- Transistor Simulation
- Logic Simulation
- Hardware Emulation
- Technology CAD
- Field Solvers

Validation:
- ATPG
- BIST

Analysis and Verification:
- Functional Verification
- Clock Domain Crossing
- Formal Verification
- Equivalence Checking
- Static Timing Analysis
- Physical Verification

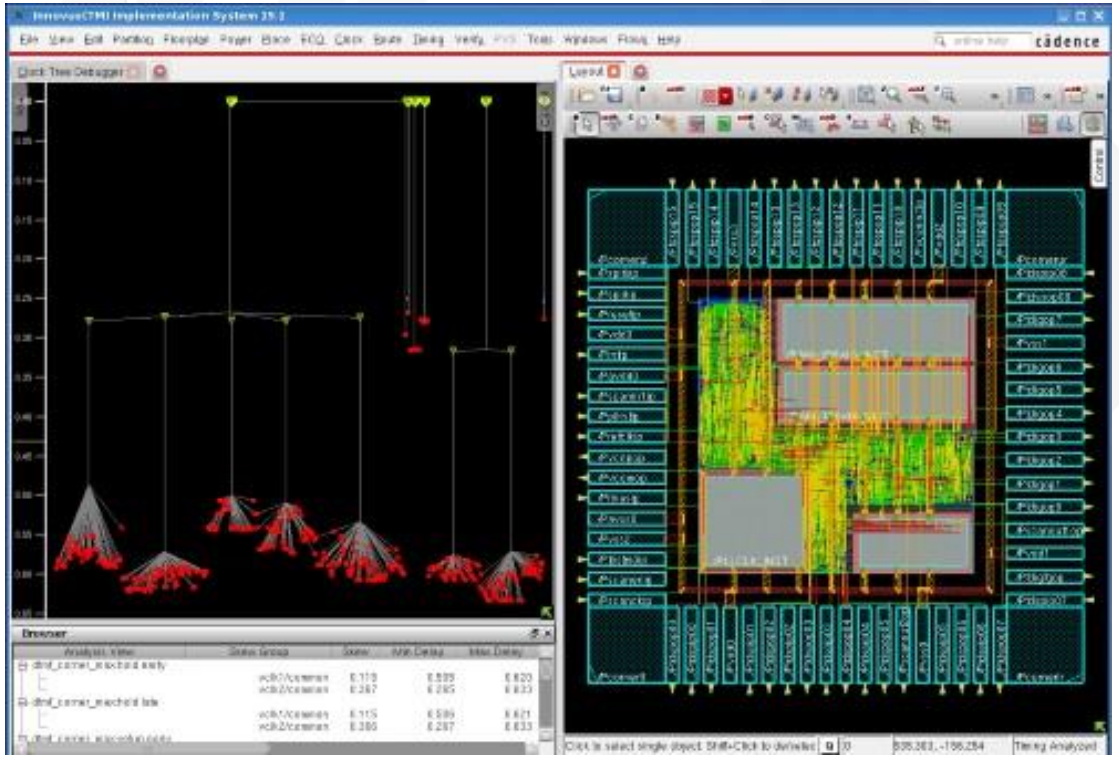
Mask Preparation:
- Optical Proximity Correction (OPC)
- Resolution Enhancement Techniques
- Mask Generation

EDA in this Course

- **RTL**
  - Verilog
- **Synthesis**
  - Cadence Genus
- **Place and Route**
  - Cadence Innovus
  - Static Timing Analysis – Tempus
  - Power Estimation – Voltus
  - Parasitic Extraction – QRC
  - Clock Tree Synthesis - CCOpt
- **Logic Simulation**
  - Cadence Incisive

cadence®

ACADEMIC NETWORK



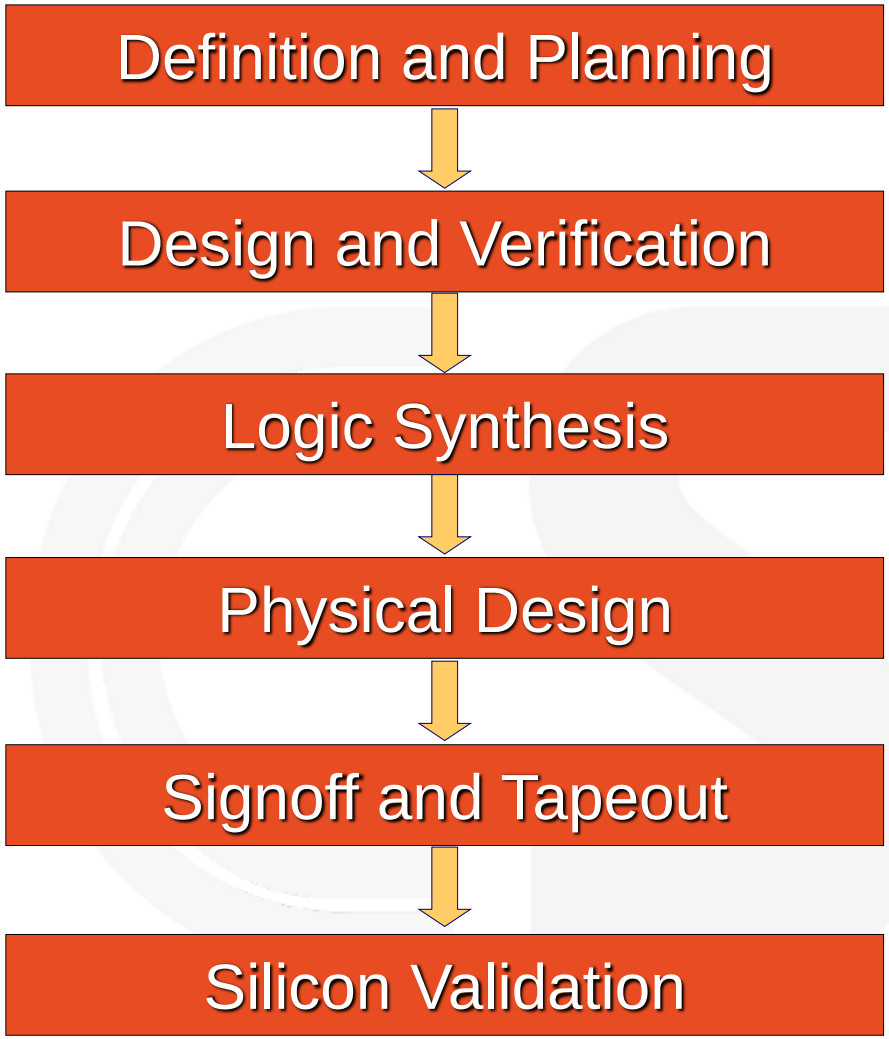
Source: IEEE Electronics 360

Chip Design Flow

How a chip is built

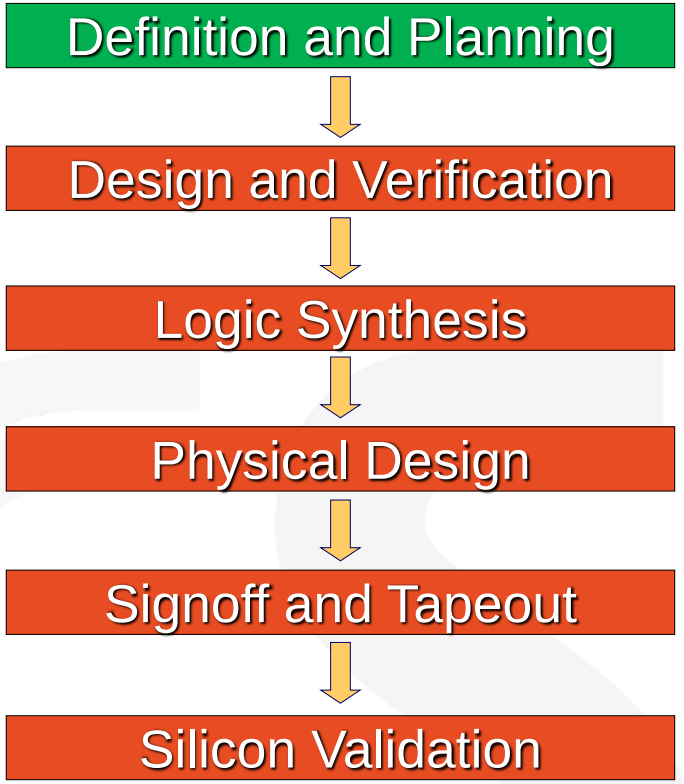
- Definition and Planning
- Design and Verification (Frontend)
- Logic Synthesis (Frontend and Backend)
- Physical Design (Backend)
- Signoff and Tapeout
- Silicon Validation

- Don’t forget package & board design, software design, test plan, etc., etc., etc.



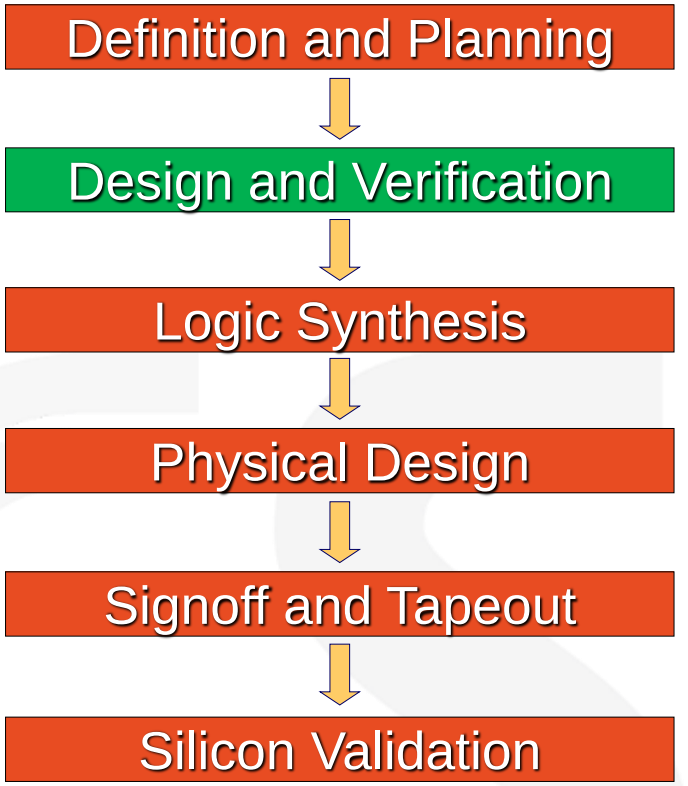
Definition & Planning

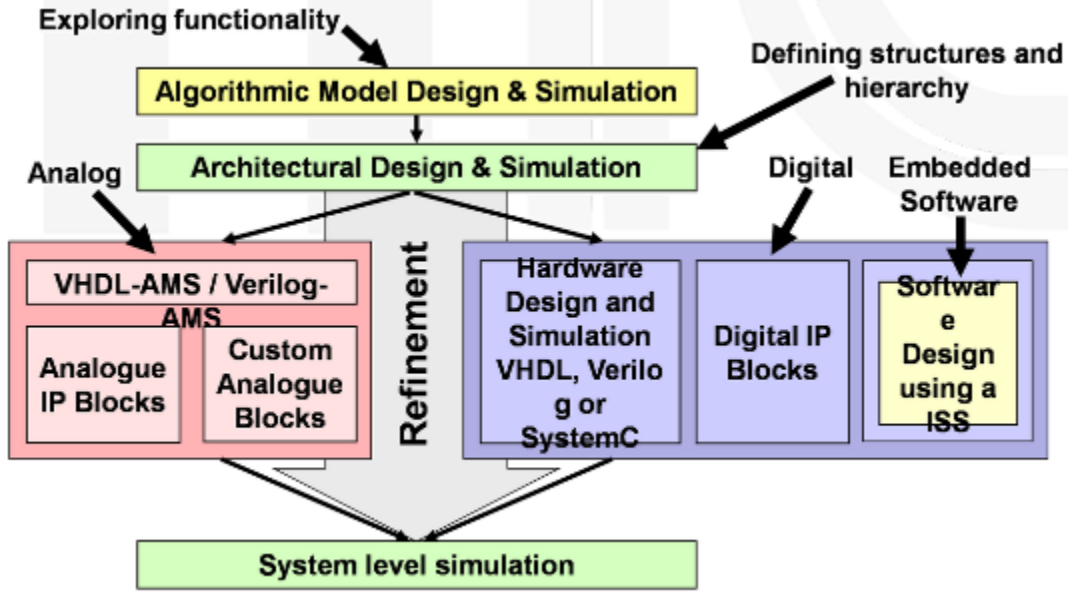
- **Marketing Requirements Document (MRD)**
- **Chip Architecture**
  - Define bus structures, connectivity
  - Partition Functionality
  - High-Level System Model (Bandwidths, Power, Freq.)
  - System partitioning (HW vs SW, #Cores, Memories…)
- **Design Documents**
- **Floorplan/Board Requirements**
- **Process and fab**
- **Project kick-off – transfer to implementation**



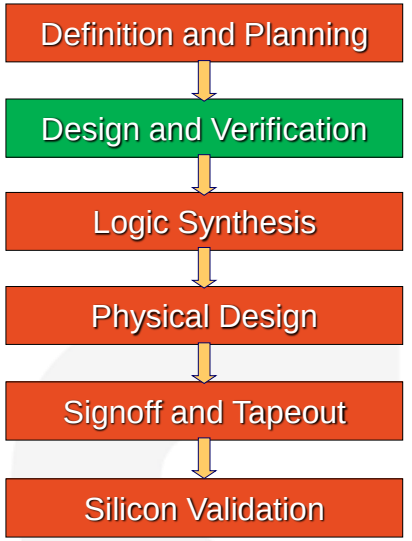
Design and Verification

- **RTL (Register Transfer Level) Design**
- **Integration/Development of IPs**
- **RTL Lint/Synthesability checks**
- **Formal Verification**
- **Functional verification all the IPs:**
  - Unit level
  - Sub-system level
  - Chip (SOC) level





Design and Verification - IP Integration



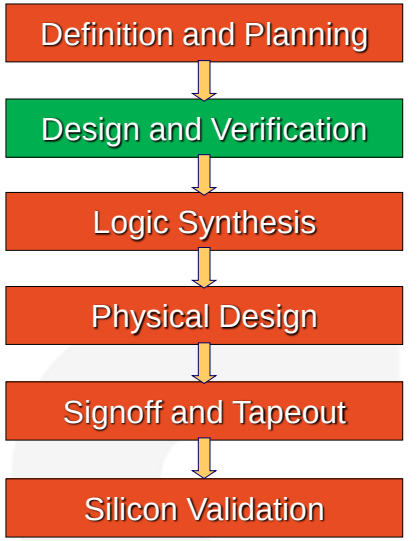
- **Hard IP**
  - IP provided as pre-existing layouts with:
    - Timing models
    - Layout abstracts
    - Behavioral models (Verilog/VHDL)
    - Sometimes with Spice models, full-layouts
  - This is the standard delivery format for custom digital blocks
    - RAMs, ROMs, PLLs, Processors
- **Soft IP**
  - RTL Code
    - Can be encrypted
    - Instantiated just like any other RTL block
  - Sometimes with behavioral models

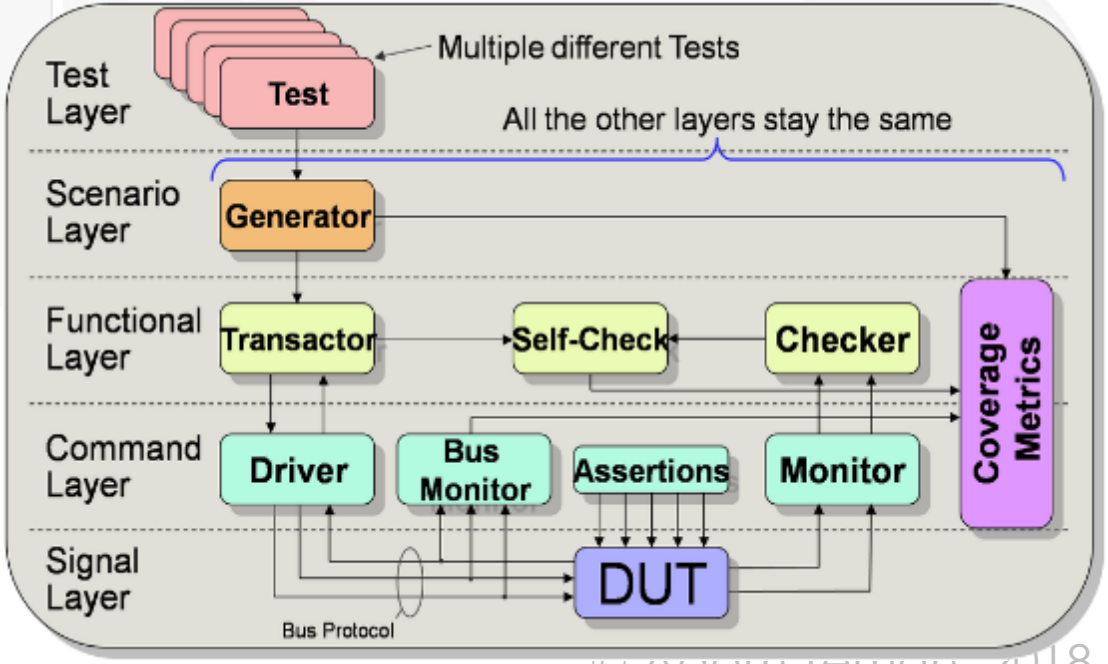
Design and Verification - Prototyping

- **Different levels of verification:**
  - Specification driven testing
  - Bug driven testing
  - Coverage driven testing
  - Regression
- **FPGA Prototyping:**
  - Synthesize to FPGA
  - Speeds up testing where possible.
- **Hardware Emulation:**
  - Big servers that can emulate the entire design.

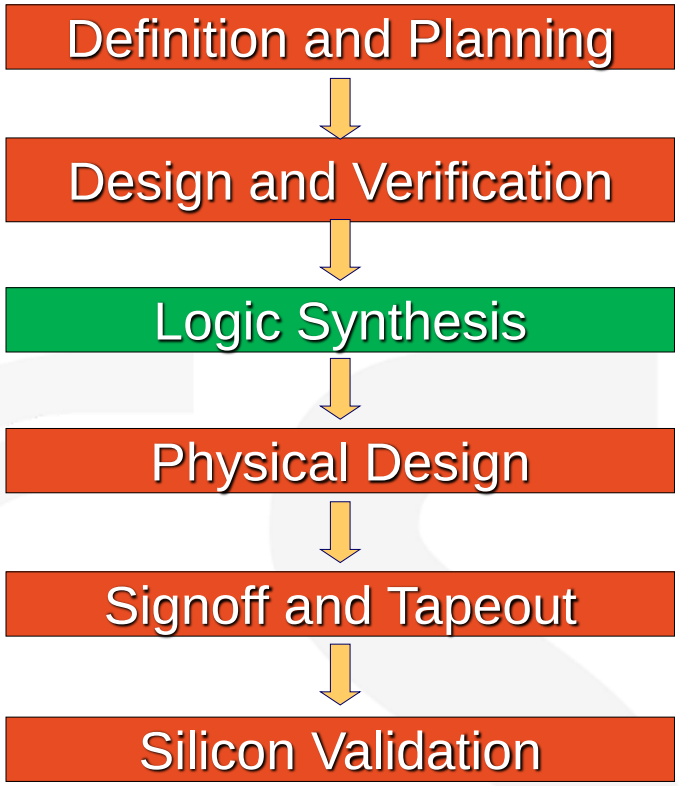
Source: Cadence

Source: mouser.com





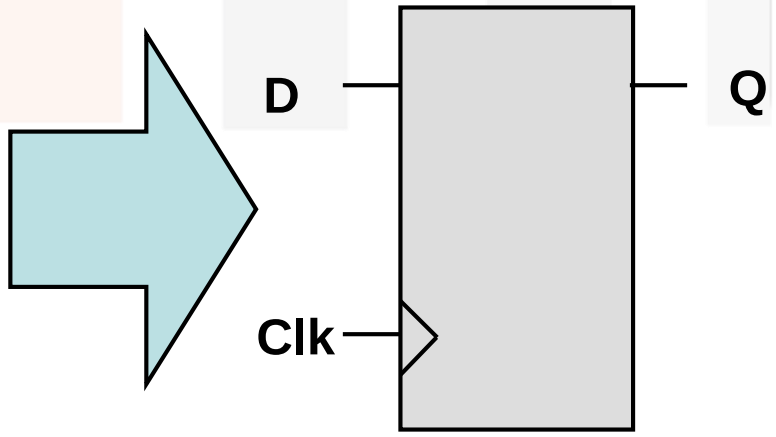
Logic Synthesis



- **Inputs:**
  - Technology library file
  - RTL files
  - Constraint files (SDC)
  - DFT definitions
- **Output:**
  - Gate-level netlist

- **Synthesis**
  - Converting RTL code into a generic logic netlist
- **Mapping**
  - Mapping generic netlist into standard cells from the core library
- **Optimization**
  - To meet Timing / Area / Power constraints

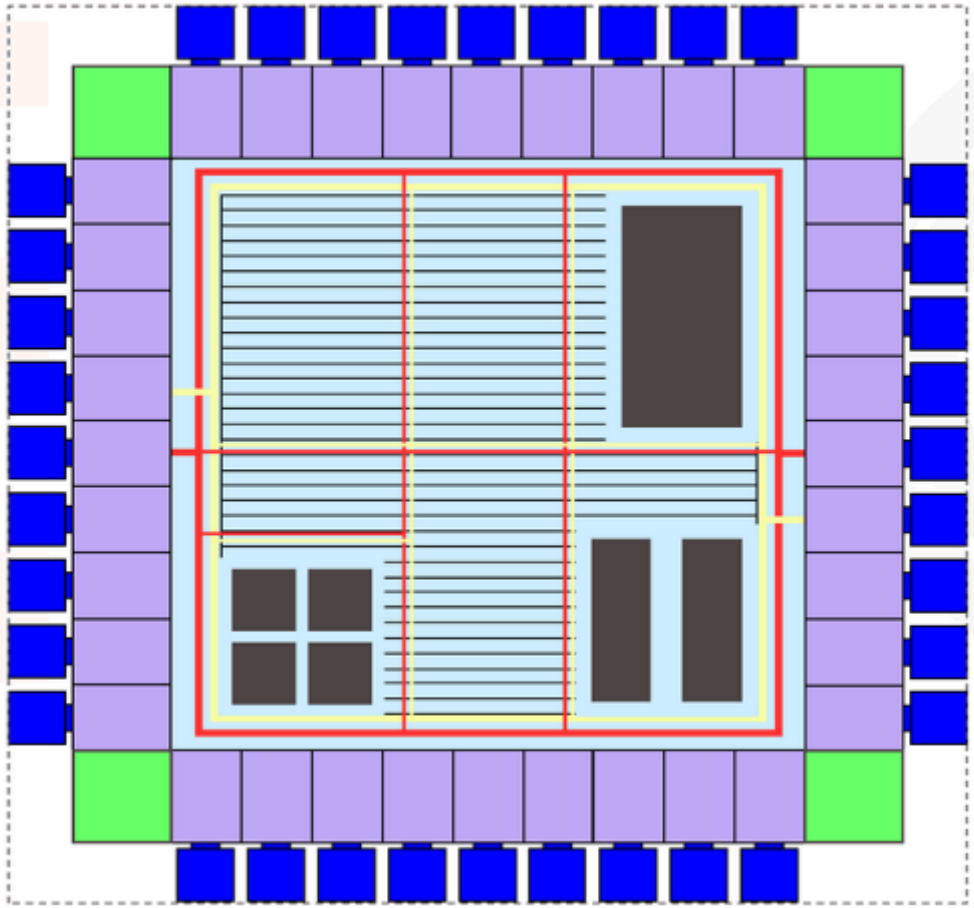
```
module DFF(Clk, D, Q);
  input Clk;
  input D;
  output Q;
  always @(posedge Clk)
    Q <= D;
endmodule
```

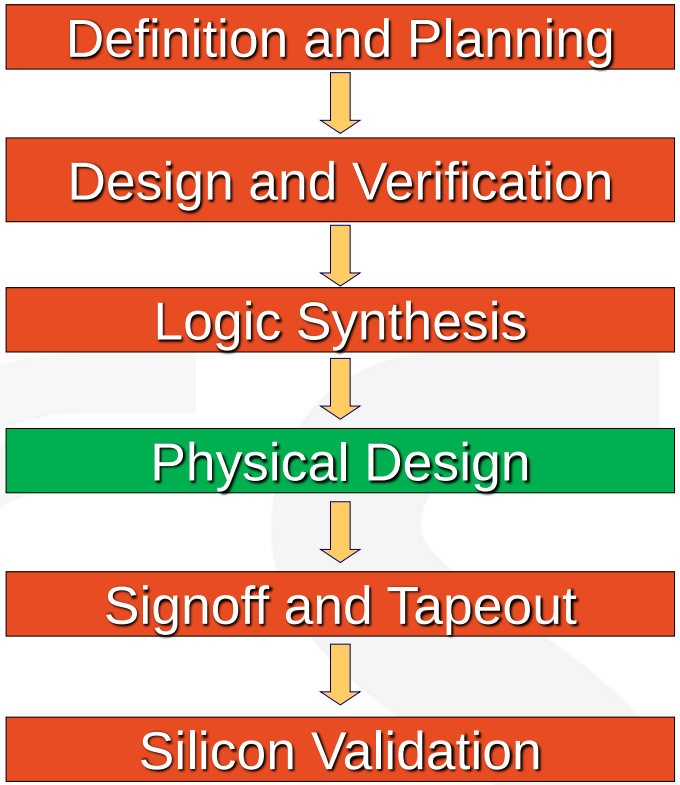


- **Post Synthesis checks**
  - Gate-level simulation
  - Formal verification (Logic Equivalence)
  - Static Timing Analysis (STA)
  - Power/Area estimation

Physical Design (Backend)

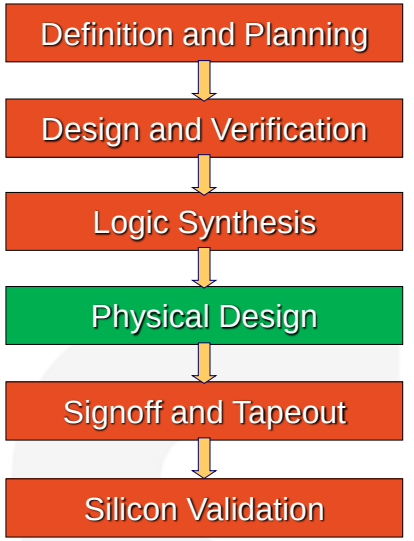
- Floorplan
- I/O Ring
- Power Plan
- Placement
- Clock Tree Synthesis
- Route
- DRC, LVS, Antennas, EM
- LEC, Post-layout

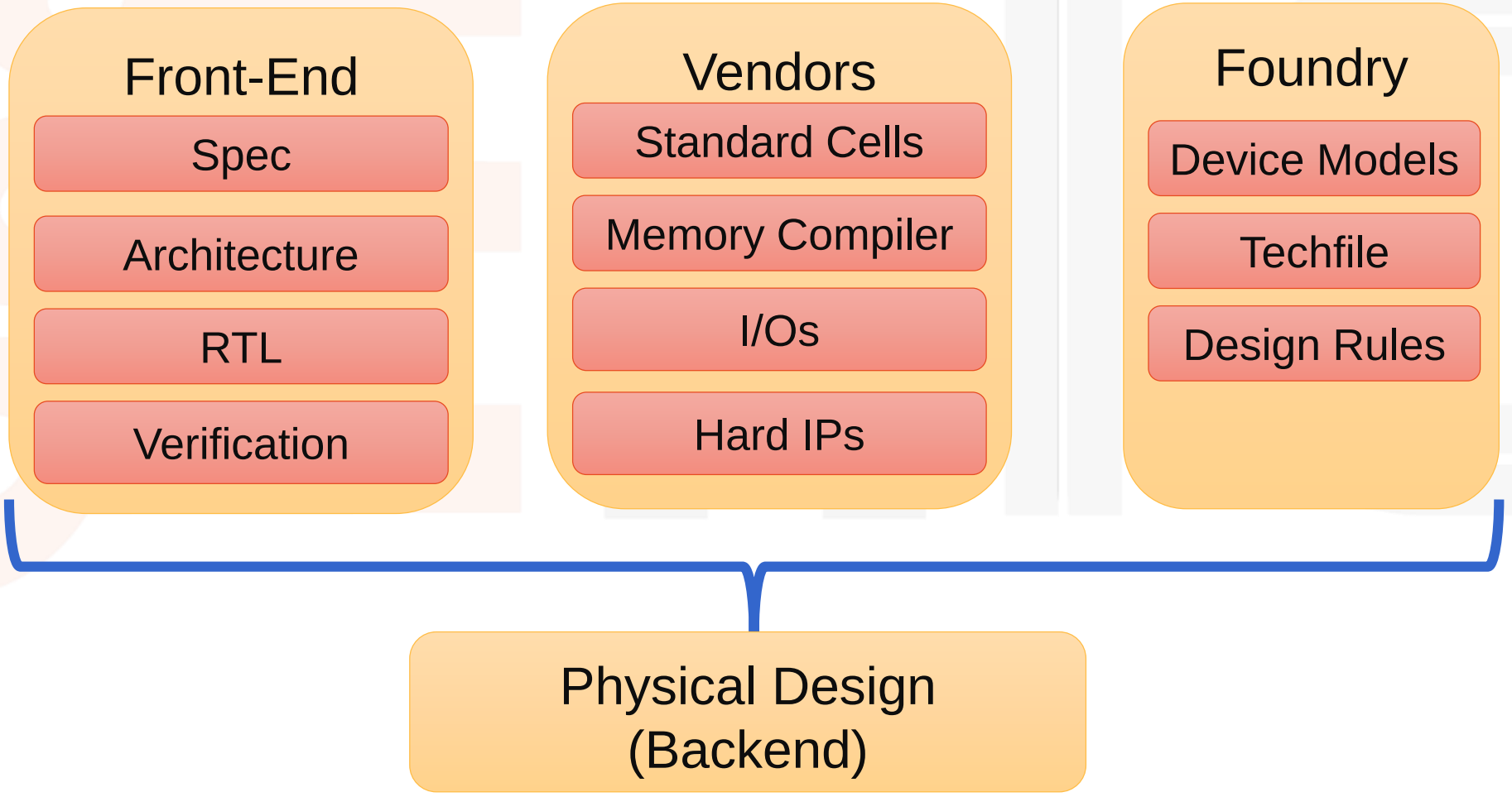




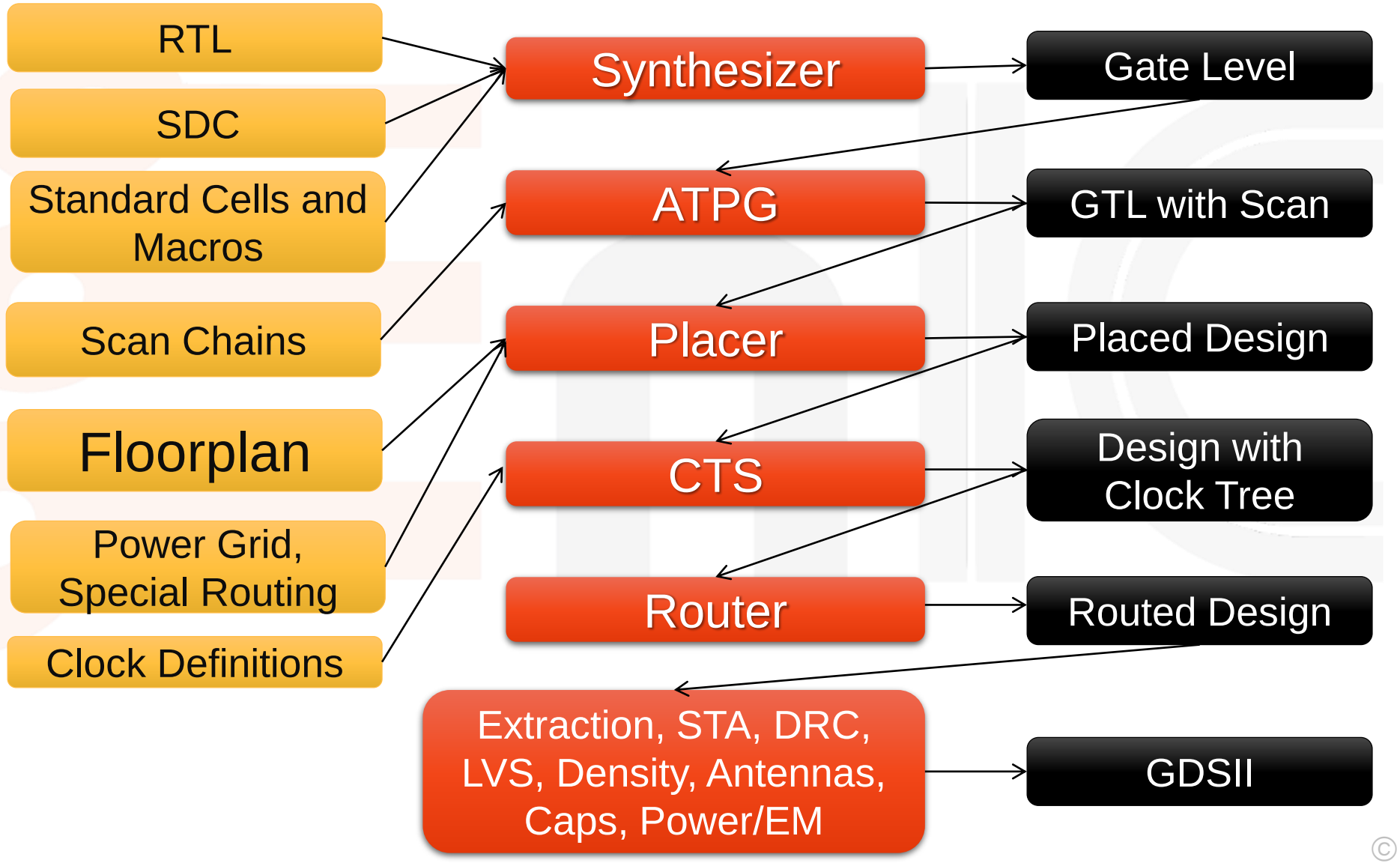
Physical Design – Backend Flow

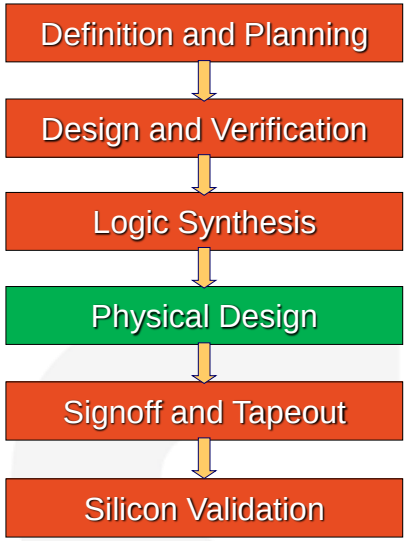
- **Physical Implementation Inputs**





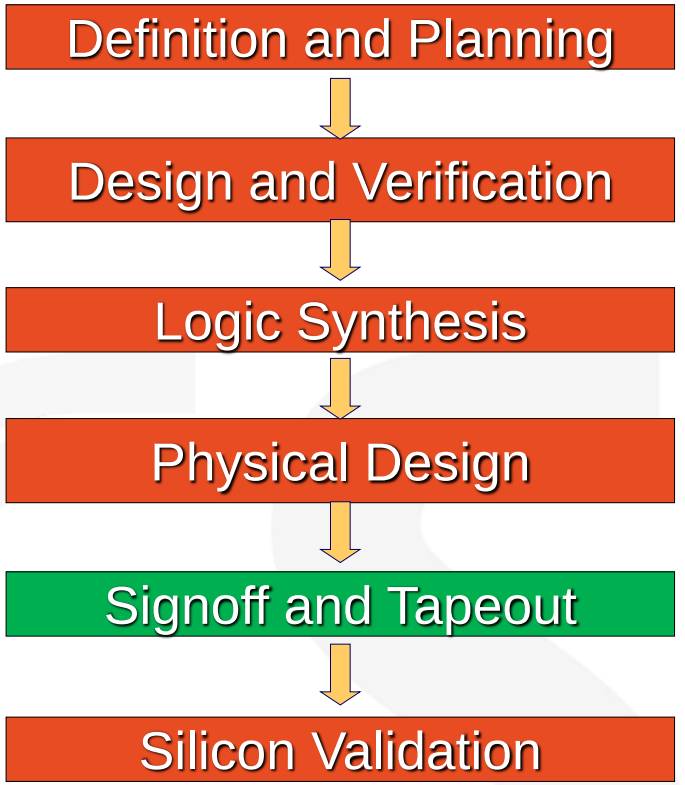
Physical Design – Backend Flow





Signoff and Tapeout

- Parasitic Extraction
- STA with SI
- DRC/LVS/ERC/DFM
- Post-layout Gate-level Simulation
- Power Analysis
- DFT
- Logic Equivalence



Glossary

- **Just to cover most of the terminology of today's lesson:**
  - RTL
  - GTL
  - CAD
  - EDA
  - DFT (ATPG, Scan, BIST)
  - OPC
  - Frontend
  - Backend
  - Verification
  - Signoff
  - Tapeout
  - Hard IP
  - Soft IP
  - FPGA
  - Emulation
  - Lint
  - Formal Verification
  - STA
  - SDC
  - SI
  - DRC, LVS, EM
  - GDSII

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